Power LDMOS transistor

Rev. 5 — 1 September 2015

## 1. Product profile

### 1.1 General description

A 1400 W extremely rugged LDMOS power transistor for broadcast and industrial applications in the HF to 128 MHz band.

#### Table 1.Application information

Test signal	f	V <sub>DS</sub>	PL	G <sub>p</sub>	η <sub>D</sub>
	(MHz)	(V)	(W)	(dB)	(%)
CW	108	50	1200	23	80
pulsed RF	108	50	1400	28	72

## **1.2 Features and benefits**

- Typical pulsed performance at frequency of 108 MHz, a supply voltage of 50 V and an  $I_{Dq}$  of 40 mA, a  $t_p$  of 100  $\mu$ s with  $\delta$  of 20 %:
  - Output power = 1400 W
  - Power gain = 28 dB
  - Efficiency = 72 %
- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (HF to 128 MHz)
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

### 1.3 Applications

- Industrial, scientific and medical applications
- Broadcast transmitter applications

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# 2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
BLF178>	(R (SOT539A)		
1	drain1		
2	drain2		1
3	gate1		3
4	gate2		3 - 5
5	source	[1]	

[1] Connected to flange.

## 3. Ordering information

#### Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BLF178XR	-	flanged balanced LDMOST ceramic package; 2 mounting holes; 4 leads	SOT539A		
BLF178XRS	-	earless flanged balanced LDMOST ceramic package; 4 leads	SOT539B		

## 4. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage		-	110	V
V <sub>GS</sub>	gate-source voltage		-6	+11	V
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	200	°C

## 5. Thermal characteristics

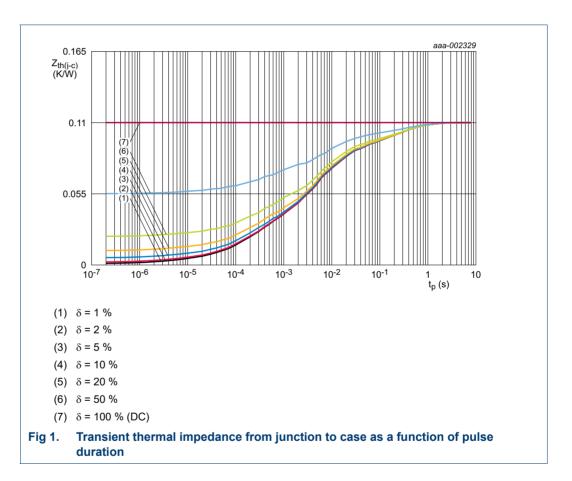
#### Table 5. Thermal characteristics

Symbol	Parameter	Conditions		Тур	Unit
R <sub>th(j-c)</sub>	thermal resistance from junction to case	T <sub>j</sub> = 150 °C	[1][2]	0.11	K/W
Z <sub>th(j-c)</sub>	transient thermal impedance from junction to case	$\begin{array}{l} \textbf{T}_{j} = 150 ~^{\circ}\text{C}; ~ \textbf{t}_{p} = 100 ~ \mu\text{s}; \\ \delta = 20 ~\% \end{array}$	<u>[3]</u>	0.033	K/W

[1] T<sub>i</sub> is the junction temperature.

[2] Rth(j-c) is measured under RF conditions.

[3] See Figure 1.



## 6. Characteristics

#### Table 6. DC characteristics

 $T_i = 25 \ ^{\circ}C$ ; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	V <sub>GS</sub> = 0 V; I <sub>D</sub> = 5.5 mA	110	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	V <sub>DS</sub> = 10 V; I <sub>D</sub> = 550 mA	1.25	1.7	2.25	V
$V_{GSq}$	gate-source quiescent voltage	$V_{DS}$ = 50 V; I <sub>D</sub> = 20 mA	0.8	1.3	1.8	V
I <sub>DSS</sub>	drain leakage current	$V_{GS}$ = 0 V; $V_{DS}$ = 50 V	-	-	2.8	μA
I <sub>DSX</sub>	drain cut-off current	$\label{eq:VGS} \begin{array}{l} V_{\mathrm{GS}} = V_{\mathrm{GS}(\mathrm{th})} + 3.75 \ \mathrm{V}; \\ V_{\mathrm{DS}} = 10 \ \mathrm{V} \end{array}$	-	77	-	А
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = 11 V; $V_{DS}$ = 0 V	-	-	280	nA
R <sub>DS(on)</sub>	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 V;$ $I_D = 19.25 A$	-	0.07	-	Ω

#### Table 7. AC characteristics

 $T_i = 25 \ ^{\circ}C$ ; per section unless otherwise specified.

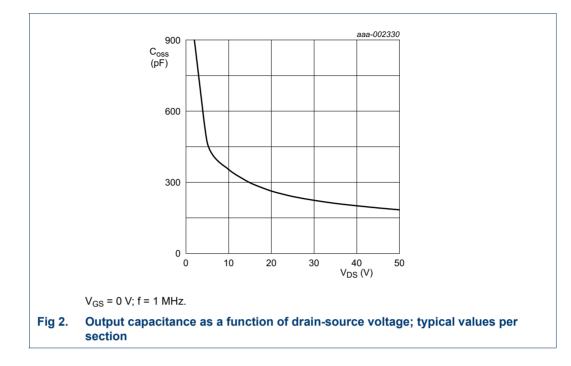
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
C <sub>rs</sub>	feedback capacitance	$V_{GS}$ = 0 V; $V_{DS}$ = 50 V; f = 1 MHz	-	5.5	-	pF
C <sub>iss</sub>	input capacitance	$V_{GS}$ = 0 V; $V_{DS}$ = 50 V; f = 1 MHz	-	414	-	pF
C <sub>oss</sub>	output capacitance	$V_{GS}$ = 0 V; $V_{DS}$ = 50 V; f = 1 MHz	-	184	-	pF

#### Table 8. RF characteristics

Test signal: pulsed RF;  $t_p = 100 \ \mu s$ ;  $\delta = 20 \ \%$ ;  $f = 108 \ MHz$ ; RF performance at  $V_{DS} = 50 \ V$ ;  $I_{Dq} = 40 \ mA$ ;  $T_{case} = 25 \ ^{\circ}C$ ; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
G <sub>p</sub>	power gain	P <sub>L</sub> = 1400 W	27	28	-	dB
RL <sub>in</sub>	input return loss	P <sub>L</sub> = 1400 W	-	-15	-11	dB
$\eta_D$	drain efficiency	P <sub>L</sub> = 1400 W	68	72	-	%

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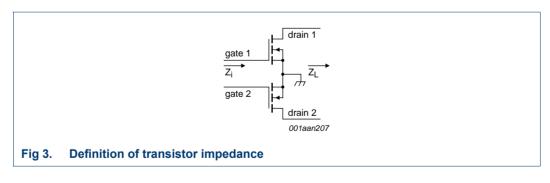


# 7. Test information

### 7.1 Ruggedness in class-AB operation

The BLF178XR and BLF178XRS are capable of withstanding a load mismatch corresponding to VSWR > 65 : 1 through all phases under the following conditions:  $V_{DS} = 50 \text{ V}$ ;  $I_{Dq} = 40 \text{ mA}$ ;  $P_L = 1400 \text{ W}$  pulsed; f = 108 MHz.

### 7.2 Impedance information



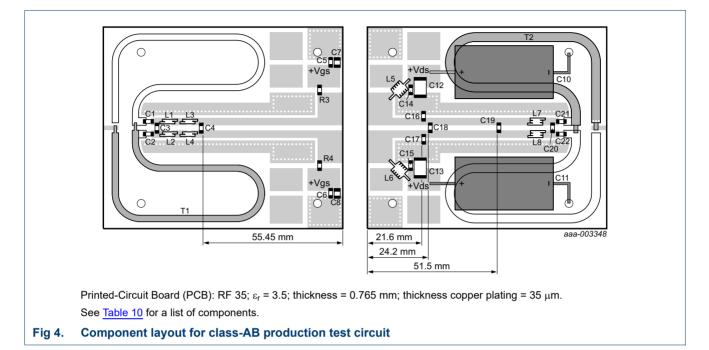
#### Table 9.Typical push-pull impedance

Simulated  $Z_i$  and  $Z_L$  device impedance; impedance info at  $V_{DS}$  = 50 V and  $P_L$  = 1400 W.

f	Z <sub>i</sub>	ZL
(MHz)	(Ω)	(Ω)
108	2.35 – j6.06	2.78 + j0.48

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### 7.3 Test circuit



# Table 10.List of componentsFor test circuit see Figure 4.

Component	Description	Value	Remarks
C1, C2, C5, C6, C14, C15, C21, C22	multilayer ceramic chip capacitor	1 nF	<u>[1]</u>
C3	multilayer ceramic chip capacitor	82 pF	[1]
C4	multilayer ceramic chip capacitor	240 pF	[1]
C7, C8	multilayer ceramic chip capacitor	4.7 μF; 50 V	
C10, C11	electrolytic capacitor	2200 μF; 63 V	
C12, C13	multilayer ceramic chip capacitor	4.7 μF; 100 V	
C16, C17	multilayer ceramic chip capacitor	120 pF	[1]
C18	multilayer ceramic chip capacitor	82 pF	[1]
C19	multilayer ceramic chip capacitor	110 pF	[1]
C20	multilayer ceramic chip capacitor	56 pF	[1]
L1, L2, L3, L4	1.5 turn 0.8 mm copper wire	D = 3 mm; length = 2 mm	
L5, L6	5 turn 0.8 mm copper wire	D = 3 mm; length = 4.5 mm	
L7, L8	2.5 turn 0.8 mm copper wire	D = 3 mm; length = 3 mm	
R3, R4	SMD resistor	9.1 Ω	1206
T1	semi rigid coax	25 Ω; 160 mm	UT-090C-25
T2	semi rigid coax	25 Ω; 160 mm	UT-141C-25

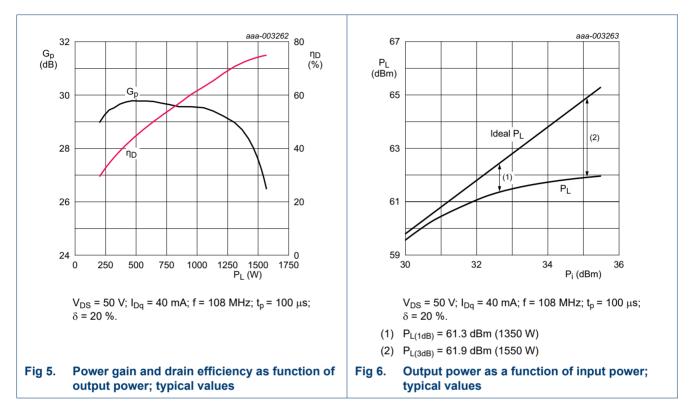
[1] American Technical Ceramics type 800B or capacitor of same quality.

BLF178XR\_BLF178XRS#5

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### 7.4 Graphical data

The following figures are measured in a class-AB production test circuit.

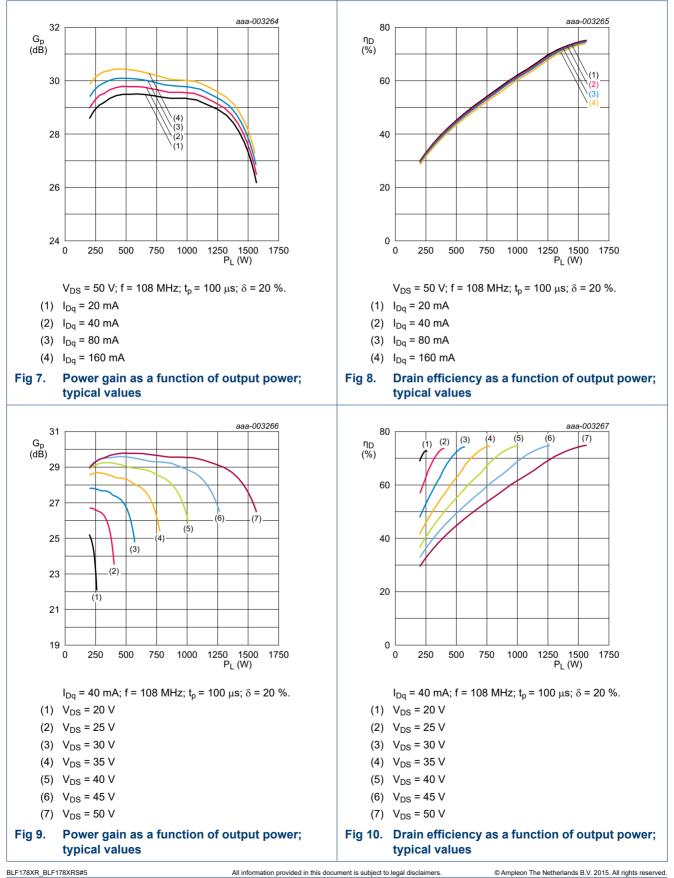


### 7.4.1 1-Tone CW pulsed

# AMPLEON

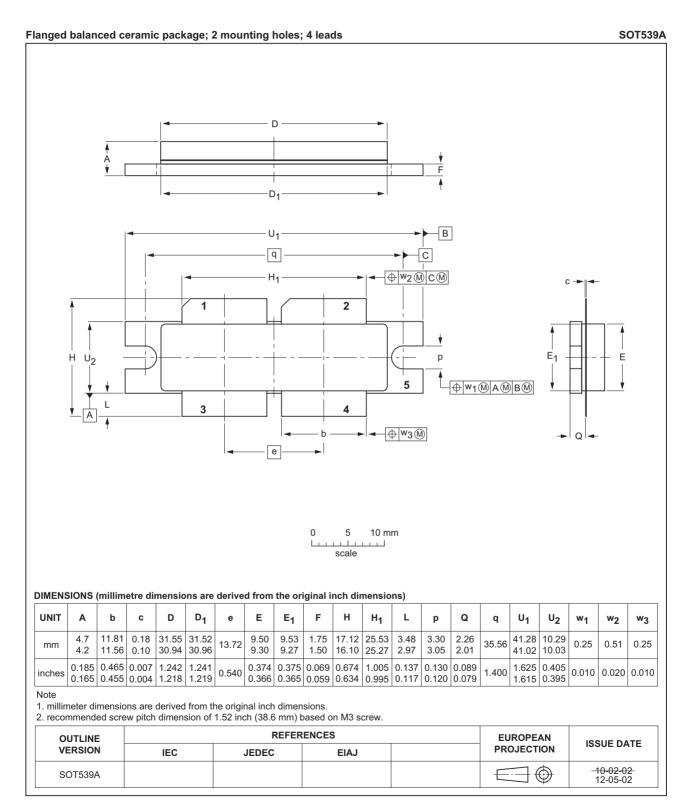
# BLF178XR; BLF178XRS

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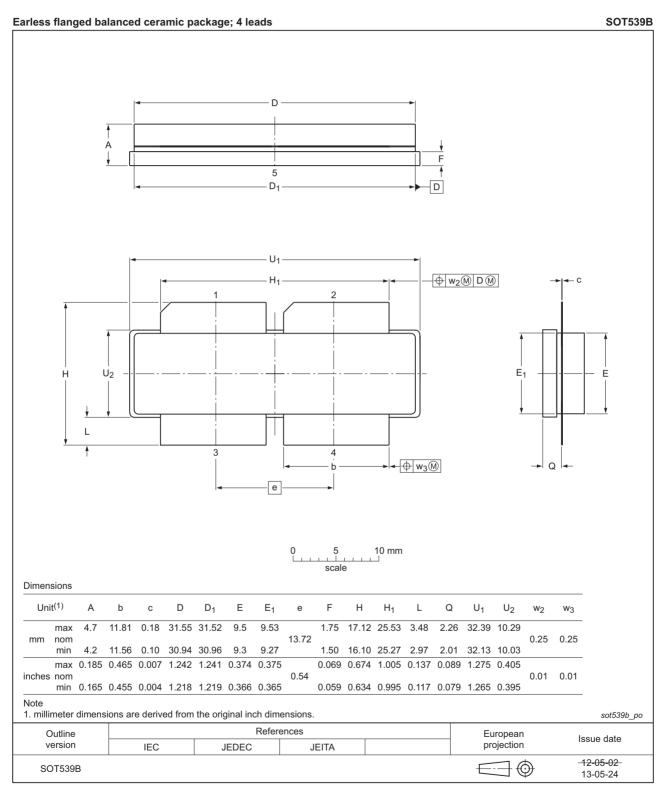
**Power LDMOS transistor** 

## 8. Package outline



### Fig 11. Package outline SOT539A

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### Fig 12. Package outline SOT539B

## 9. Handling information

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

# **10. Abbreviations**

Table 11.	Table 11.   Abbreviations				
Acronym	Description				
CW	Continuous Wave				
ESD	ElectroStatic Discharge				
HF	High Frequency				
LDMOS	Laterally Diffused Metal-Oxide Semiconductor				
LDMOST	Laterally Diffused Metal-Oxide Semiconductor Transistor				
SMD	Surface Mounted Device				
VSWR	Voltage Standing-Wave Ratio				

## **11. Revision history**

#### Table 12.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLF178XR_BLF178XRS#5	20150901	Product data sheet	-	BLF178XR_BLF178XRS v.4
Modifications:	The format guidelines of		en redesigned to c	omply with the new identity
	<ul> <li>Legal texts</li> </ul>	have been adapted to the	ne new company na	ame where appropriate.
BLF178XR_BLF178XRS v.4	<tbd></tbd>	Product data sheet	-	BLF178XR_BLF178XRS v.3
BLF178XR_BLF178XRS v.3	20120625	Product data sheet	-	BLF178XR_BLF178XRS v.2
BLF178XR_BLF178XRS v.2	20120515	Preliminary data sheet	-	BLF178XR_BLF178XRS v.1
BLF178XR_BLF178XRS v.1	20120130	Objective data sheet	-	-

# 12. Legal information

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Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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